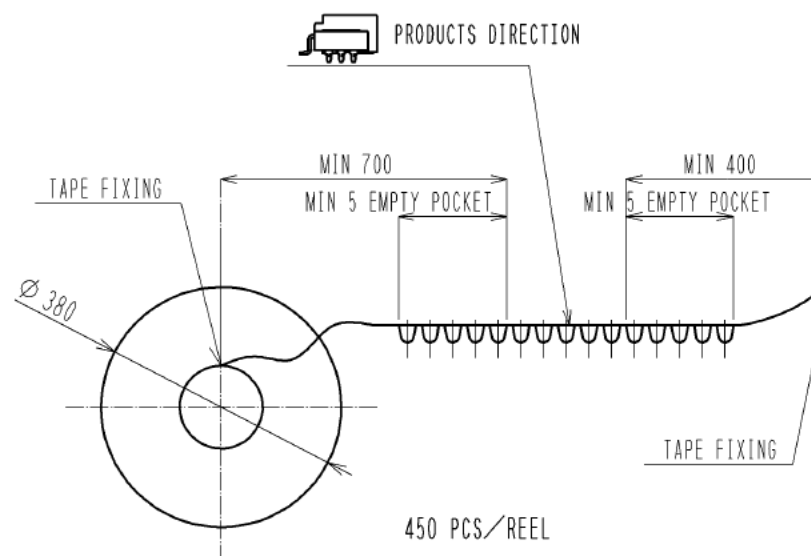
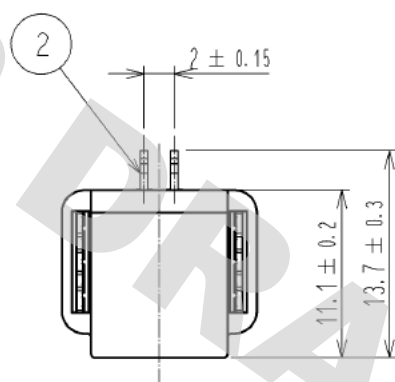
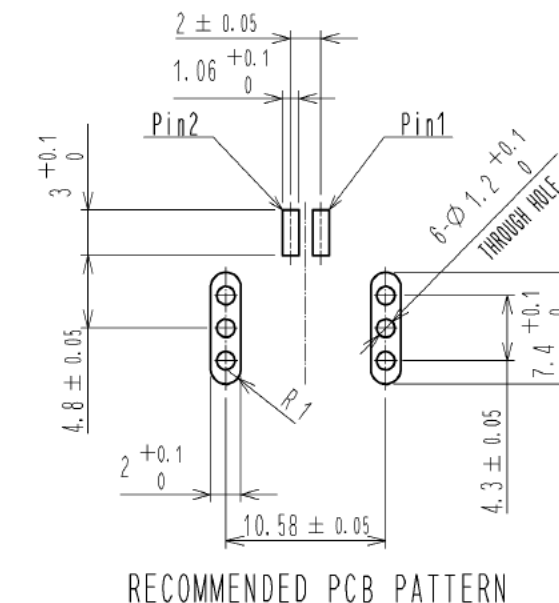


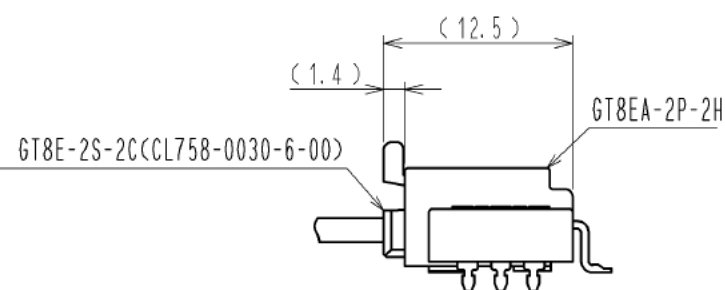
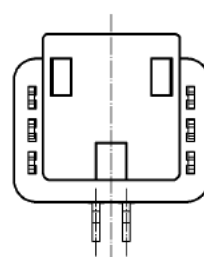
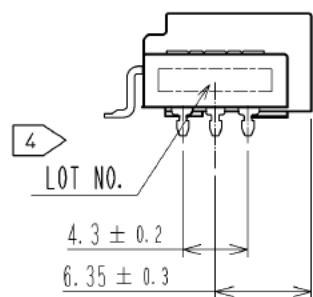
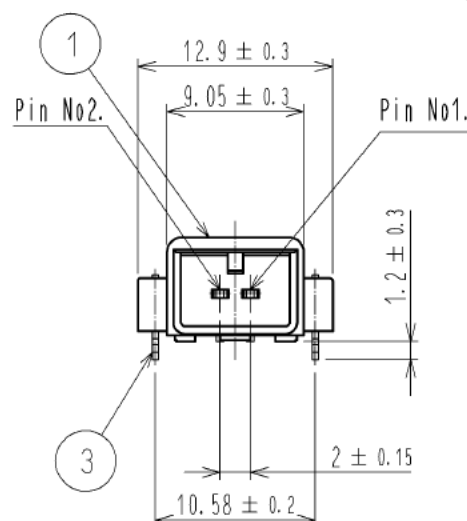
ELV, RoHS COMPLIANT



EMBOSS PACKING SPECIFICATIONS(FREE)



RECOMMENDED PCB PATTERN



MATED CONNECTORS

NOTE 1. RECOMMENDED REFLOW TEMPERATURE PROFILE (REFER RIGHT FIG.).

REFLOW HEATING: FAR-INFLARED, IN THE AIR OR NITROGEN

NUMBER OF REFLOW CYCLES: 2 CYCLES MAX

PEAK TEMPERATURE: 250°C

ABOVE 230°C: 20~40s

PREHEAT: 150~180°C (60~120s)

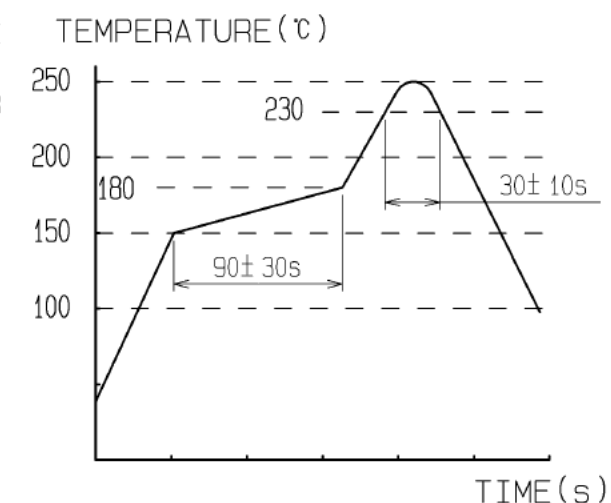
2. SOLDERING TEMPERATURE: 280~300°C (MAX 2s)

3. CO-PLANARITY OF LEADS SHALL BE 0.1mm MAX.

4. MARKING OF LOT NO. (EX) 2012.7TH. NOVEMBER → 2012.K.07

5. RECOMMENDED THICKNESS FOR PC BOARD IS 1.6mm.

6. RECOMMENDED THICKNESS FOR SOLDER PASTE IS 0.15mm.



2	BRASS	TIN PLATING	3	BRASS	TIN PLATING
1	PPS	BLACK			
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm		SCALE 2 : 1	COUNT △	DESCRIPTION OF REVISIONS	DESIGNED CHECKED DATE
APPROVED : AR. SHIRAI		12.12.04	DRAWING NO. EDC3-169419-00		
CHECKED : NH. NAKATA		12.12.04	PART NO. GT8EA-2P-2H		
DESIGNED : RZ. KANO		12.12.04	CODE NO. CL758-0113-1-00		
DRAWN : RZ. KANO		12.12.04	△ 1/1		

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